## GA01PNS150-220



# Silicon Carbide PiN Diode

#### **Features**

- 15 kV blocking
- 250 °C operating temperature
- Fast turn off characteristics
- Soft reverse recovery characteristics
- Ultra-Fast high temperature switching

## **Advantages**

- Industry's first > 10 kV power rectifier
- · Reduced stacking
- · Reduced system complexity/Increased reliability



## **Applications**

- Voltage Multiplier
- Ignition/Trigger Circuits
- Oil/Downhole
- Lighting
- Defense

## Maximum Ratings at T<sub>i</sub> = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	$V_{RRM}$		15	kV
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> ≤ 150 °C	1	Α
RMS forward current	I <sub>F(RMS)</sub>	T <sub>C</sub> ≤ 150 °C	0.5	Α
Operating and storage temperature	$T_j$ , $T_stg$		-55 to 250	°C

### Electrical Characteristics at T<sub>i</sub> = 250 °C, unless otherwise specified

Parameter	Cumhal	Conditions -		Values		I I m i 4	
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	$V_{F}$	I <sub>F</sub> = 1 A, T <sub>j</sub> = 25 °C		6.5	7.0	V	
		I <sub>F</sub> = 1 A, T <sub>j</sub> = 225 °C		4.4	5.0	V	
Reverse current	I <sub>R</sub>	$V_R = 15 \text{ kV}, T_j = 2$	25 °C		1	20	
		$V_R = 15 \text{ kV}, T_j = 225 ^{\circ}\text{C}$			5	100	μΑ
Total reverse recovery charge	$Q_{rr}$	I <sub>F</sub> ≤ I <sub>F,MAX</sub>	V <sub>R</sub> = 1000 V I <sub>F</sub> = 1.5 A		558		nC
Switching time	ts	T = 225 °C	V <sub>R</sub> = 1000 V I <sub>F</sub> = 1.5 A		< 236		ns
Total capacitance		$V_R = 1 \text{ V, } f = 1 \text{ MHz, } T_j = 25 ^{\circ}\text{C}$		28			
	С	$V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$		8		pF	
		$V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$		7			
Total capacitive charge	$Q_C$	V <sub>R</sub> = 1000 V, f = 1 MHz	, T <sub>j</sub> = 25 °C	•	5.34		nC

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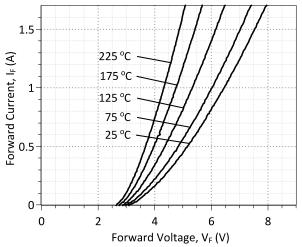


Figure 1: Typical Forward Characteristics

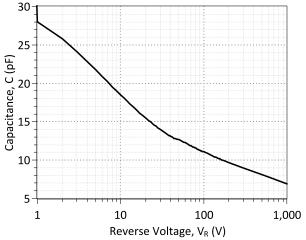


Figure 3: Typical Junction Capacitance vs Reverse Voltage Characteristics

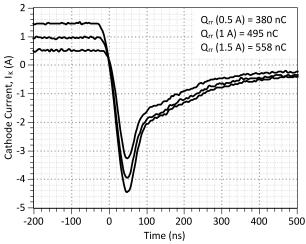


Figure 5: Typical Turn Off Characteristics at  $T_{j}$  = 225  $^{\circ}\text{C}$  and  $V_{R}$  = 1000 V

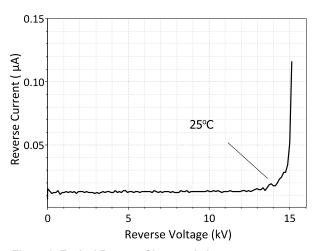


Figure 2: Typical Reverse Characteristics

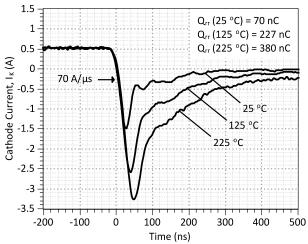


Figure 4: Typical Turn Off Characteristics at  $I_{k}$  = 0.5 A and  $V_{R}$  = 1000 V

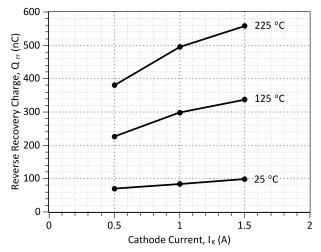


Figure 6: Reverse Recovery Charge vs Cathode Current

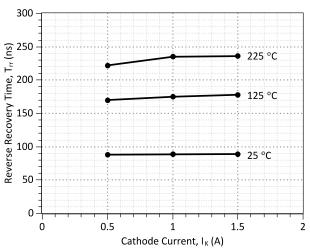


Figure 7: Reverse Recovery Time vs Cathode Current

Revision History						
Date	Revision	Comments	Supersedes			
2014/09/15	0	Initial release				

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## **SPICE Model Parameters**

Copy the following code into a SPICE software program for simulation of the GA01PNS150-220 device.

```
MODEL OF GeneSiC Semiconductor Inc.
     $Revision: 1.0
     $Date: 15-SEP-2014
    GeneSiC Semiconductor Inc.
     43670 Trade Center Place Ste. 155
     Dulles, VA 20166
    http://www.genesicsemi.com/index.php/hit-sic/baredie
    COPYRIGHT (C) 2014 GeneSiC Semiconductor Inc.
     ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GA01PNS150-220 SPICE Model
.MODEL GA01PNS150 D
+ IS
      9.71E-12
         2.07
+ RS
+ N
         5.7869
+ IKF
         0.039646
         3.23
+ EG
+ XTI
         58
+ TRS1
         -0.0034
         2.28E-11
+ CJO
         2.304
+ VJ
+ M
         0.376
+ FC
          0.5
+ BV
         16000
+ IBV
         1.00E-03
         15000
+ VPK
+ IAVE
+ TYPE
         SiC PiN
+ MFG
         GeneSiC Semi
* End of GA01PNS150-220 SPICE Model
```